# PME295, Metallized Impregnated Paper, Class Y1, 440 VAC/480 VAC



#### **Overview**

The PME295 is constructed of multilayer metallized paper encapsulated and impregnated in self-extinguishing material, meeting the requirements of UL 94 V-0.

#### **Applications**

Safety capacitors for bridging of double or reinforced insulation applications, requiring voltage testing up to 4,000 VAC at 60 seconds. PME295 capacitors can be left in place during this test.

#### **Benefits**

· Approvals: ENEC, UL, cUL, CQC

Rated voltage: 440 VAC/480 VAC 50/60 Hz

• Capacitance range: 470 - 4,700 pF

· Lead spacing: 15.0 mm

• Capacitance tolerance: ±20%

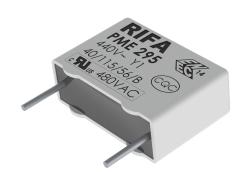
Climatic category: 40/115/56/B, IEC 60068-1

• Tape & Reel packaging in accordance with IEC 60286-2

· RoHS Compliant and lead-free terminations

Operating temperature range of -40°C to +115°C

 100% screening factory test at 4,000 VAC, 50 Hz, 2 seconds



## **Legacy Part Number System**

PME295	R	В	3470	M	R30
Series	Rated Voltage (VAC)	Lead Spacing (mm)	Capacitance Code (pF)	Capacitance Tolerance	Packaging
Y1, Metallized Paper	R = 440	B = 15.0	The last three digits represent significant figures. The first digit specifies the total number of digits.	M = ±20%	See Ordering Options Table

## **New KEMET Part Number System**

Р	295	В	E	471	M	440	Α
Capacitor Class	Series	Lead Spacing (mm)	Size Code	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VAC)	Packaging
P = Paper	Y1, Metallized Paper	B = 15.0	See Dimension Table	First two digits represent significant figures. Third digit specifies number of zeros.	M = ±20%	440 = 440	See Ordering Options Table

One world. One KEMET



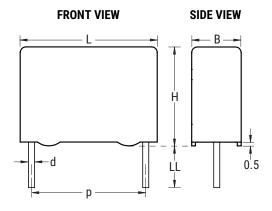
#### **Benefits cont'd**

- Highest possible safety regarding active and passive flammability
- Excellent self-healing properties ensure long life even when subjected to frequent over voltages
- · Good resistance to ionization due to impregnated dielectric
- High dV/dt capability
- Impregnated paper provides excellent stability and reliability properties, particularly in applications with continuous operation

## **Ordering Options Table**

Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	KEMET Lead and Packaging Code	Legacy Lead and Packaging Code
	Standard Lead and Packaging Options			
4=	Bulk (Bag) – Short leads	6 +0/-1	С	R06
15	Bulk (Bag) – Maximum length leads	30 +5/-0	Α	R30
	Tape & Reel (Standard reel Φ = 360 mm)	$H_0 = 18.5 \pm 0.5$	L	R19T0
Native 15 formed to 7.5	Tape & Reel (Standard reel Φ = 360 mm)	$H_0 = 18.5 \pm 0.5$	XLTF1	R25X2

#### **Dimensions - Millimeters**



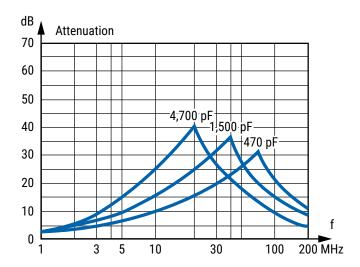
	рВ		ı	Н		L		d			
Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance		
15	±0.4	5.5	Maximum	12.5	Maximum	18	Maximum	0.8	±0.05		
15	±0.4	6.5	Maximum	12.5	Maximum	18	Maximum	0.8	±0.05		
15	±0.4	7.5	Maximum	14.5	Maximum	18	Maximum	0.8	±0.05		
15	±0.4	8.5	Maximum	16 Maximum		18	Maximum	0.8	±0.05		
	Note: See Ordering Options Table for lead length (LL) options.										



## **Performance Characteristics**

Rated Voltage	440 VAC 50/60 Hz (ENEC)				
Nateu Voltage	480 VAC 50/60 Hz (UL, cUL)				
Capacitance Range	0.00047 - 0.0047 μF				
Capacitance Tolerance	±20%				
Temperature Range	-40°C to +115°C				
Climatic Category	40/115/56/B				
Approvals	ENEC, UL, cUL, CQC				
Dissipation Footon	Maximum Values at +23°C				
Dissipation Factor	1 kHz 1.3%				
Test Voltage Between Terminals	The 100% screening factory test is carried out at 4,000 VAC, 50 Hz, 2 seconds. The voltage level is selected to meet the requirements in applicable equipment standards. All electrical characteristics are checked after the test.				
	Measured at 500 VDC a	fter 60 seconds, +23°C			
Insulation Resistance	Between 1	Ferminals:			
	12,000 ΜΩ				
In DC Applications	Recommended voltage ≤ 1,500 VDC				
Resonance Frequency	Tabulated self-resonance freque length	ncies f <sub>0</sub> refer to 5 mm lead			

# **Suppression vs. Frequency, Typical Values**





## **Environmental Test Data**

Test	IEC Publication	Procedure
Endurance	IEC 60384-14	1.7 x V <sub>R</sub> Vac 50 Hz, once every hour increase to 1,000 VAC for 0.1 second, 1,000 hours at upper rated temperature.
Vibration	IEC 60068-2-6 Test Fc	3 directions at 2 hours each 10 - 500 Hz at 0.75 mm or 98 m/s²
Bump	IEC 60068-2-29 Test Eb	4,000 bumps at 390 m/s <sup>2</sup>
Change of Temperature	IEC 60068-2-14 Test Na	Upper and lower rated temperature 5 cycles
Passive Flammability	IEC 60384-14	IEC 60384-1, IEC 60695-11-5 Needle flame test
Humidity	IEC 60068-2-3 Test Ca	+40°C and 93% RH, 56 days

# **Approvals**

<b>Certification Body</b>	Mark	Specification	File Number		
Intertek Semko AB		EN/IEC 60384-14 (440 VAC)	SE/0140-13D		
UL		UL 60384-14	E73869		
OL	c 744 us	CAN/CSA-E60384-14:09	L/3009		
cqc	Cec	IEC 60384-14	CQC16001145221		

# **Environmental Compliance**

All KEMET EMI capacitors are RoHS Compliant.





## **Table 1 - Ratings & Part Number Reference**

Capacitance	Maxim	Maximum Dimensions in Lead Spacing		f (MHz)	dV/dt	New KEMET Part	Legacy Part	
Value (µF)	В	Н	L	(p)	(MHz)	(V/µs)	Number	Number
0.00047	5.5	12.5	18	15	64	2,000	P295BE471M440(1)	PME295RB3470M(1)
0.00056	5.5	12.5	18	15	59	2,000	P295BE561M440(1)	PME295RB3560M(1)
0.00068	5.5	12.5	18	15	54	2,000	P295BE681M440(1)	PME295RB3680M(1)
0.00082	5.5	12.5	18	15	49	2,000	P295BE821M440(1)	PME295RB3820M(1)
0.001	5.5	12.5	18	15	46	2,000	P295BE102M440(1)	PME295RB4100M(1)
0.0012	6.5	12.5	18	15	43	2,000	P295BJ122M440(1)	PME295RB4120M(1)
0.0015	6.5	12.5	18	15	40	2,000	P295BJ152M440(1)	PME295RB4150M(1)
0.0018	6.5	12.5	18	15	37	2,000	P295BJ182M440(1)	PME295RB4180M(1)
0.0022	6.5	12.5	18	15	33	2,000	P295BJ222M440(1)	PME295RB4220M(1)
0.0025	7.5	14.5	18	15	31	2,000	P295BL252M440(1)	PME295RB4250M(1)
0.0027	7.5	14.5	18	15	30	2,000	P295BL272M440(1)	PME295RB4270M(1)
0.0033	7.5	14.5	18	15	27	2,000	P295BL332M440(1)	PME295RB4330M(1)
0.0039	8.5	16	18	15	24	2,000	P295BQ392M440(1)	PME295RB4390M(1)
0.0047	8.5	16	18	15	22	2,000	P295BQ472M440(1)	PME295RB4470M(1)
Capacitance Value (µF)	B (mm)	H (mm)	L (mm)	Lead Spacing (p)	f <sub>。</sub> (MHz)	dV/dt (V/µs)	New KEMET Part Number	Legacy Part Number

<sup>(1)</sup> Insert ordering code for lead type and packaging. See Ordering Options Table for available options.



## **Soldering Process**

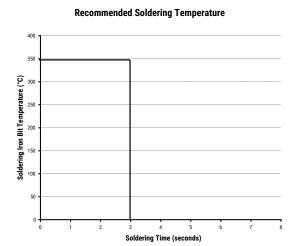
The implementation of the RoHS directive has resulted in the selection of SnAuCu (SAC) alloys or SnCu alloys as primary solder. This has increased the liquidus temperature from 183°C for SnPb eutectic alloys to 217 – 221°C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher preheat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 – 170°C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 to 15 mm), and great care must be taken during soldering. The recommended solder profiles from KEMET should be used. Consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1, Edition 2 serves as a solid guideline for successful soldering. See Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above the recommended limits may result in degradation of or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert through-hole parts after the curing of surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum of two soldering cycles is recommended. Allow time for the capacitor surface temperature to return to normal before the second soldering cycle.

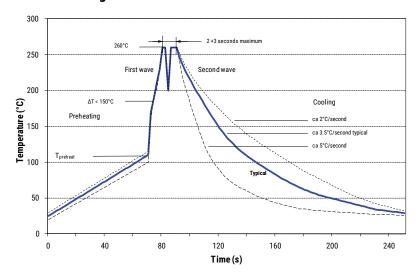
#### **Manual Soldering Recommendations**

Following is the recommendation for manual soldering with a soldering iron.



The soldering iron tip temperature should be set at 350°C (+10°C maximum) with the soldering duration not to exceed more than 3 seconds.

#### **Wave Soldering Recommendations**





#### **Soldering Process cont'd**

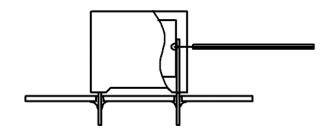
#### **Wave Soldering Recommendations cont'd**

1. The table indicates the maximum set-up temperature of the soldering process Figure 1

Dielectric Film Material	Maximun	n Preheat Tem	Maximum Peak Soldering Temperature			
	Capacitor Pitch ≤ 10 mm	Capacitor Pitch = 15 mm	Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm	
Polyester	130°C	130°C	130°C	270°C	270°C	
Polypropylene	100°C	110°C	130°C	260°C	270°C	
Paper	130°C	130°C	140°C	270°C	270°C	
Polyphenylene sulphide	150°C	150°C	160°C	270°C	270°C	

2. The maximum temperature measured inside the capacitor: set the temperature so that inside the element the maximum temperature is below the limit.

Dielectric Film Material	Maximum Temperature Measured Inside the Element
Polyester	160°C
Polypropylene	110°C
Paper	160°C
Polyphenylene sulphide	160°C



Temperature monitored inside the capacitor.

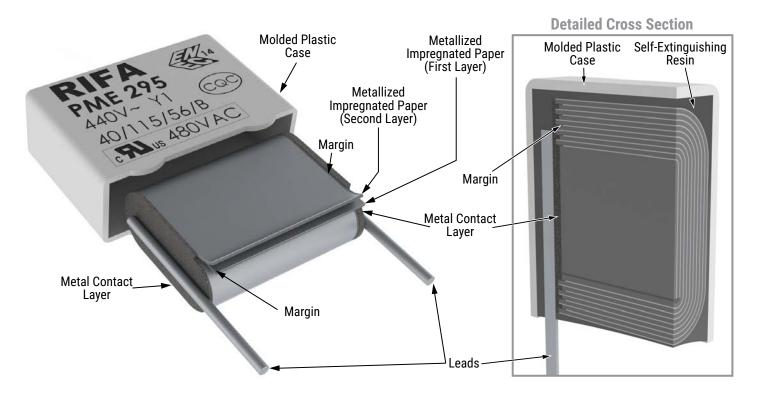
#### **Selective Soldering Recommendations**

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath, as in normal-flow soldering, without touching the solder. When the board is over the bath, it is stopped. Pre-designed solder pots are lifted from the bath with molten solder only at the places of the selected components, and then pressed against the lower surface of the board to solder the components.

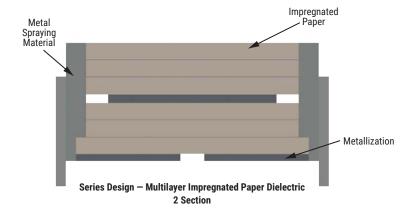
The temperature profile for selective soldering is similar to the temperature profile for double-wave flow soldering outlined in this document. However, instead of two baths, there is only one with a time from 3 to 10 seconds. In selective soldering, the risk of overheating is greater than in double-wave flow soldering, and great care must be taken so that the parts do not overheat.



#### Construction

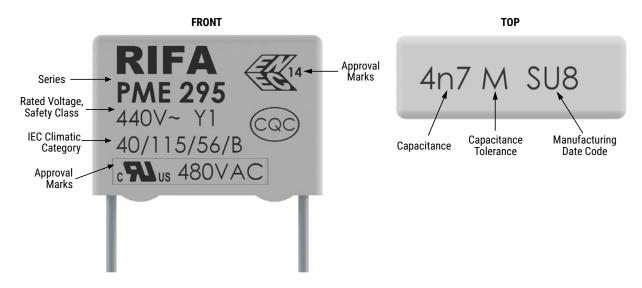


#### **Winding Scheme**





# Marking

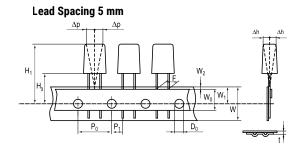


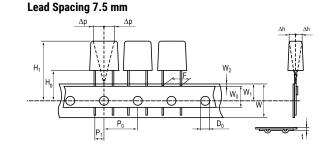
# **Packaging Quantities**

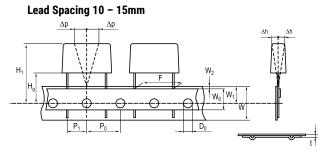
Lead Spacing (mm)	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Bulk Long Leads	Standard Reel 360 mm	Standard Reel Formed
	Lead and Packagi	ing Code		C/R06	A/R30	L/R19T0	XLTF1/R25X2
	5.5	12.5	18.0	1,000	500	600	-
15	7.5	14.5	18.0	600	400	400	350
15	6.5 12.5		18.0	600	400	400	400
	8.5	16	18.0	400	250	400	-

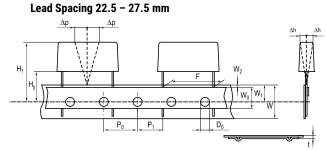


## Lead Taping & Packaging (IEC 60286-2)

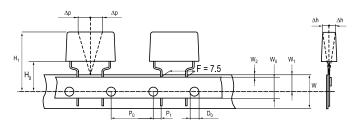








Formed Leads from 10 and 15 mm to 7.5 mm



# **Taping Specification**

	Dimensions in mm												
Lead spacing	+6/-0.1	F	5	7.5	Formed 7.5	10	15	22.5	27.5	F			
Carrier tape width	±0.5	W	18	18	18	18	18	18	18	18 +1/-0.5			
Hold-down tape width	Minimum	W <sub>o</sub>	5	5	5	5	5	5	5				
Position of sprocket hole	±0.5	W <sub>1</sub>	9	9	9	9	9	9	9	9 +0.75/-0.5			
Distance between tapes	Maximum	W <sub>2</sub>	3	3	3	3	3	3	3	3			
Sprocket hole diameter	±0.2	D <sub>0</sub>	4	4	4	4	4	4	4	4			
Feed hole lead spacing	±0.3	P <sub>0</sub> (1)	12.7	12.7	12.7 (4)	12.7	12.7	12.7	12.7	12.7			
Distance lead – feed hole	±0.7	P <sub>1</sub>	3.85	3.75	3.75	7.7	5.2	5.3	5.3	P1			
Deviation tape – plane	Maximum	Δр	1.3	1.3	1.3	1.3	1.3	1.3	1.3	1.3			
Lateral deviation	Maximum	Δh	2	2	2	2	2	2	2	2			
Total thickness	±0.2	t	0.7	0.7	0.7	0.7	0.7	0.9 Maximum	0.9 Maximum	0.9 Maximum			
Sprocket hole/cap body	Nominal	H <sub>0</sub> (2)	18.5±0.5	18.5±0.5	18.5±0.5	18.5±0.5	18.5±0.5	18.5±0.5	18.5±0.5	18.0 +2/-0			
Sprocket hole/ top of cap body	Maximum	H <sub>1</sub> (3)	32	31	43	43	43	58	58	58 Maximum			

<sup>(1)</sup> Maximum cumulative feed hole error, 1 mm per 20 parts

<sup>(2) 16.5</sup> mm available on request

<sup>(3)</sup> Depending on case size

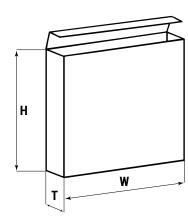
<sup>(4) 15</sup> mm available on request



## Lead Taping & Packaging (IEC 60286-2) cont'd

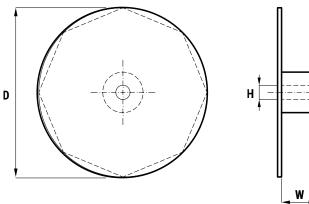
# **Ammo Specifications**

Carias	Dimensions (mm)		
Series	Н	W	Т
R4x, R4x+R, R7x, RSB			
F5A, F5B, F5D	360	340	59
F6xx, F8xx			
PHExxx, PMExxx, PMRxxx, SMR & PFR	330	330	50



# **Reel Specifications**

Series	Dimensions (mm)		
Series	D	Н	W
R4x, R4x+R, R7x, RSB	055		
F5A, F5B, F5D	355 500	30 25	55 (Max)
F6xx, F8xx	300	23	
PHExxx, PMExxx, PMRxxx, SMR & PFR	360 500	30	46 (Max)



# **Manufacturing Date Code (IEC-60062)**

Y = Year, Z = Month					
Year	Code	Month	Code		
2010	Α	January	1		
2011	В	February	2		
2012	С	March	3		
2013	D	April	4		
2014	E	May	5		
2015	F	June	6		
2016	Н	July	7		
2017	J	August	8		
2018	K	September	9		
2019	L	October	0		
2020	M	November	N		
2021	N	December	D		
2022	Р				
2023	R				
2024	S				
2025	Т				
2026	U				
2027	V				
2028	W				
2029	Х				
2030	A				



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Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicted or that other measures may not be required.